

SEMICONDUCTOR IM

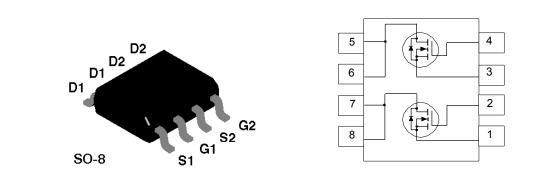
NDS9956A Dual N-Channel Enhancement Mode Field Effect Transistor

General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulses in the avalanche and commutation modes. These devices are particularly suited for low voltage applications such as DC/DC conversion and DC motor control where fast switching, low in-line power loss, and resistance to transients are needed.

Features

- 3.7A, 30V. R_{DS(ON)} = 0.08Ω @ V_{GS} = 10V
- High density cell design for extremely low R_{DS(ON)}.
- High power and current handling capability in a widely used surface mount package.
- Dual MOSFET in surface mount package.



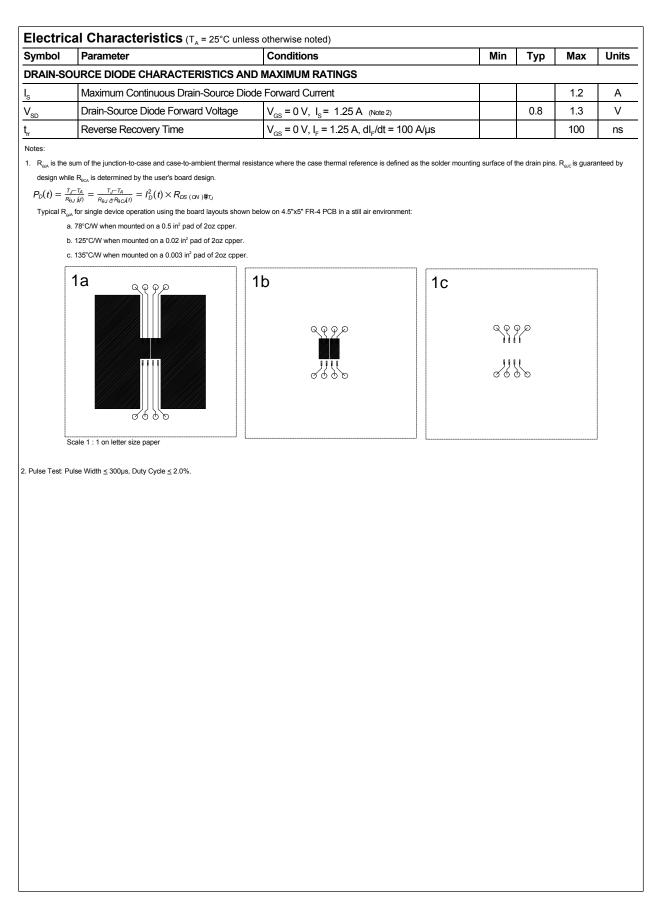
Absolute Maximum Ratings T₄= 25°C unless otherwise noted

Symbol	Parameter	NDS9956A	Units	
V _{DSS}	Drain-Source Voltage	30	V	
V _{GSS}	Gate-Source Voltage	± 20	V	
D	Drain Current - Continuous (Note 1a)	± 3.7	А	
	- Pulsed	± 15		
P _D	Power Dissipation for Dual Operation	2	W	
	Power Dissipation for Single Operation (Note 1a)	1.6		
	(Note 1b)	1		
	(Note 1c)	0.9		
Г _Ј ,Т _{STG}	Operating and Storage Temperature Range	-55 to 150	°C	
THERMA	L CHARACTERISTICS			
۲ _{θJA}	Thermal Resistance, Junction-to-Ambient (Note 1a)	78	°C/W	
R _{AJC}	Thermal Resistance, Junction-to-Case (Note 1)	40	°C/W	

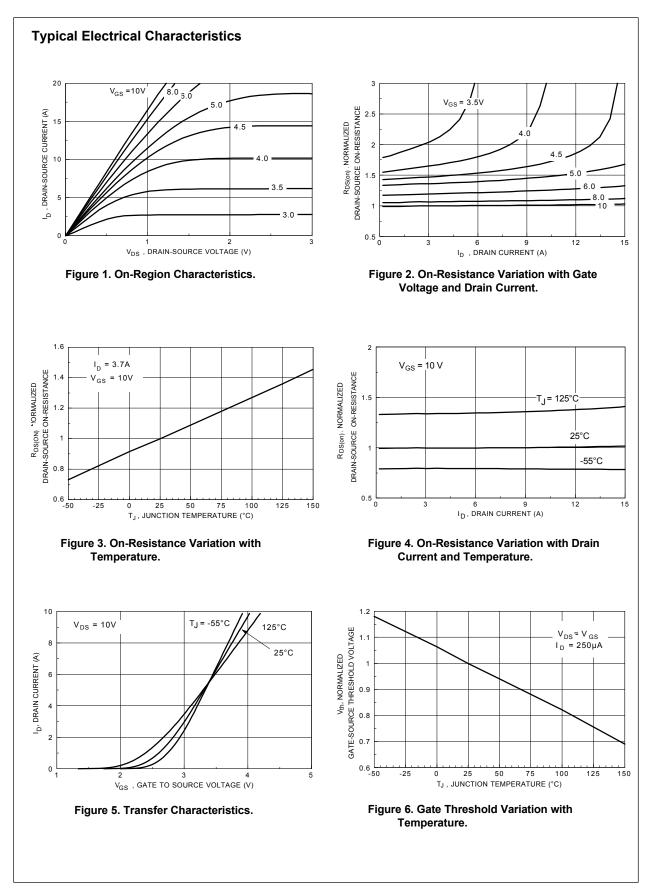
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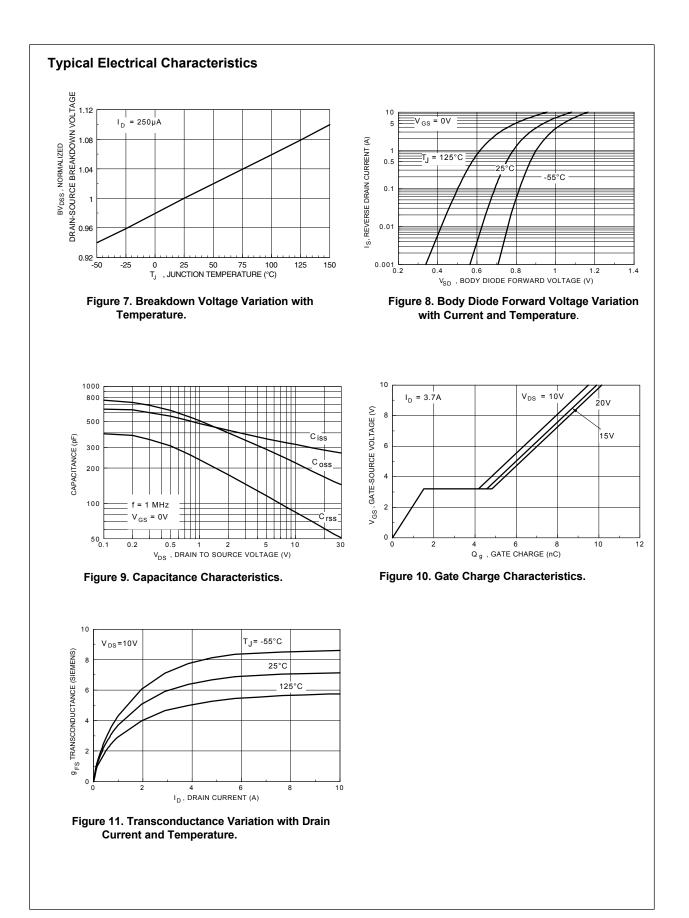
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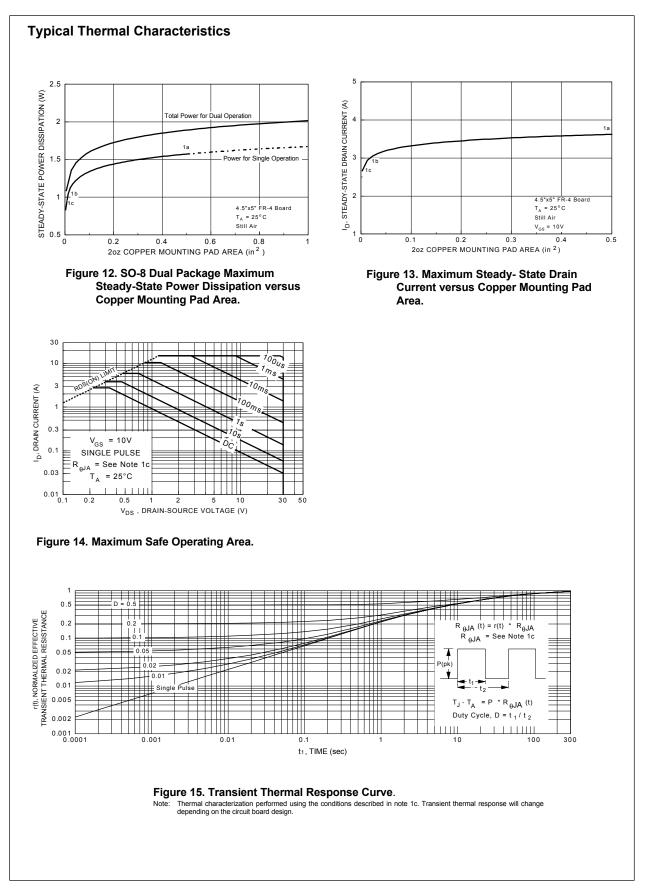
Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHA	RACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA		30			V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$				2	μA
			T _J = 55°C			25	μA
I _{GSSF}	Gate - Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$				100	nA
I _{GSSR}	Gate - Body Leakage, Reverse	$V_{GS} = -20 V, V_{DS} = 0 V$				-100	nA
ON CHAR	ACTERISTICS (Note 2)						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		1	1.7	2.8	V
			T _J = 125°C	0.7	1.2	2.2	
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 2.2 \text{ A}$			0.06	0.08	Ω
			T _J = 125°C		0.08	0.13	
		$V_{GS} = 4.5 \text{ V}, I_{D} = 1.0 \text{ A}$			0.08	0.11	1
			T _J = 125°C		0.11	0.18	1
I _{D(on)}	On-State Drain Current	V _{GS} = 10 V, V _{DS} = 10 V		15			Α
		$V_{GS} = 4.5 \text{ V}, V_{DS} = 10 \text{ V}$		3.5			
9 _{FS}	Forward Transconductance	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 3.7 \text{ A}$			6		S
DYNAMIC	CHARACTERISTICS						
C _{iss}	Input Capacitance	V _{DS} = 10 V, V _{GS} = 0 V,			320		pF
C _{oss}	Output Capacitance	f = 1.0 MHz			225		pF
C _{rss}	Reverse Transfer Capacitance				85		pF
SWITCHI	IG CHARACTERISTICS (Note 2)						
t _{D(on)}	Turn - On Delay Time	$V_{DD} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ A},$ $V_{GEN} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$			10	20	ns
t,	Turn - On Rise Time				13	20	ns
t _{D(off)}	Turn - Off Delay Time				21	50	ns
t _r	Turn - Off Fall Time				5	50	ns
Q _g	Total Gate Charge	V _{DS} = 10 V,			9.5	27	nC
Q _{gs}	Gate-Source Charge	$I_{\rm D} = 3.7 \text{A}, V_{\rm GS} = 10 \text{V}$			1.5		nC
Q _{gd}	Gate-Drain Charge				3.3		nC



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